NSS60600MZ4

Low $V_{CE(sat)}$ Transistor, PNP, 60 V, 6.0 A, SOT-223 Package

ON Semiconductor's e²PowerEdge family of low $V_{CE(sat)}$ transistors are surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC−DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- Complementary to NSS60601MZ4
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q101 Qualified and PPAP Capable
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V_{CEO}	−60	Vdc
Collector-Base Voltage	V_{CBO}	−100	Vdc
Emitter-Base Voltage	V_{EBO}	−6.0	Vdc
Collector Current − Continuous	I_C	−6.0	A
Collector Current − Peak	I_{CM}	−12.0	A

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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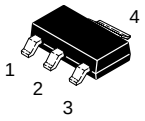
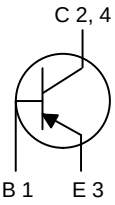
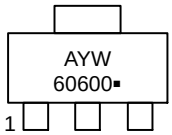
−60 VOLTS, 6.0 AMPS
2.0 WATTS
PNP LOW $V_{CE(sat)}$ TRANSISTOR
EQUIVALENT $R_{DS(on)}$ 50 mΩ



SOT−223
CASE 318E
STYLE 1

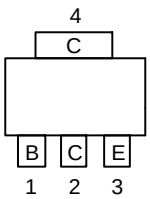


MARKING DIAGRAM



A = Assembly Location
Y = Year
W = Work Week
60600 = Specific Device Code
▪ = Pb−Free Package

PIN ASSIGNMENT



Top View Pinout

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation T_A = 25°C Derate above 25°C	P_D (Note 1)	 800 6.5	 mW mW/°C
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$ (Note 1)	 155	°C/W
Total Device Dissipation T_A = 25°C Derate above 25°C	P_D (Note 2)	 2 15.6	 W mW/°C
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$ (Note 2)	 64	°C/W
Total Device Dissipation (Single Pulse < 10 sec.)	$P_{Dsingle}$ (Note 3)	 710	mW
Junction and Storage Temperature Range	T_J, T_{stg}	−55 to +150	°C

1. FR−4 @ 7.6 mm^2, 1 oz. copper traces.
2. FR−4 @ 645 mm^2, 1 oz. copper traces.
3. Thermal response.

ORDERING INFORMATION

Device	Package	Shipping†
NSS60600MZ4T1G	SOT−223 (Pb−Free)	1,000 / Tape & Reel
NSV60600MZ4T1G	SOT−223 (Pb−Free)	1,000 / Tape & Reel
NSS60600MZ4T3G	SOT−223 (Pb−Free)	4,000 / Tape & Reel
NSV60600MZ4T3G	SOT−223 (Pb−Free)	4,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector−Emitter Breakdown Voltage (I_C = −10 mAdc, I_B = 0)	$V_{(BR)CEO}$	−60	−	−	Vdc
Collector−Base Breakdown Voltage (I_C = −0.1 mAdc, I_E = 0)	$V_{(BR)CBO}$	−100	−	−	Vdc
Emitter−Base Breakdown Voltage (I_E = −0.1 mAdc, I_C = 0)	$V_{(BR)EBO}$	−6.0	−	−	Vdc
Collector Cutoff Current (V_{CB} = −100 Vdc, I_E = 0)	I_{CBO}	−	−	−0.1	μAdc
Emitter Cutoff Current (V_{EB} = −6.0 Vdc)	I_{EBO}	−	−	−0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain (Note 4) (I_C = −500 mA, V_{CE} = −2.0 V) (I_C = −1.0 A, V_{CE} = −2.0 V) (I_C = −2.0 A, V_{CE} = −2.0 V) (I_C = −6.0 A, V_{CE} = −2.0 V)	h_{FE}	 150 120 100 70	 − − − −	 − 360 − −	−
Collector−Emitter Saturation Voltage (Note 4) (I_C = −0.1 A, I_B = −2.0 mA) (I_C = −1.0 A, I_B = −0.100 A) (I_C = −2.0 A, I_B = −0.200 A) (I_C = −3.0 A, I_B = −60 mA) (I_C = −6.0 A, I_B = −0.6 A)	$V_{CE(sat)}$	 − − − − −	 − −0.050 −0.100 − −	 −0.050 −0.070 −0.120 −0.250 −0.350	V
Base−Emitter Saturation Voltage (Note 4) (I_C = −1.0 A, I_B = −0.1 A)	$V_{BE(sat)}$	 −	 −	 −1.0	V
Base−Emitter Turn−on Voltage (Note 4) (I_C = −1.0 A, V_{CE} = −2.0 V)	$V_{BE(on)}$	 −	 −	 −0.900	V
Cutoff Frequency (I_C = −500 mA, V_{CE} = −10 V, f = 1.0 MHz)	f_T	 100	 −	 −	MHz
Input Capacitance (V_{EB} = 5.0 V, f = 1.0 MHz)	Cibo	−	360	−	pF
Output Capacitance (V_{CB} = 10 V, f = 1.0 MHz)	Cobo	−	60	−	pF
SWITCHING CHARACTERISTICS					
Delay (V_{CC} = −30 V, I_C = 750 mA, I_{B1} = 15 mA)	t_d	−	100	−	ns
Rise (V_{CC} = −30 V, I_C = 750 mA, I_{B1} = 15 mA)	t_r	−	180	−	ns
Storage (V_{CC} = −30 V, I_C = 750 mA, I_{B1} = 15 mA)	t_s	−	540	−	ns
Fall (V_{CC} = −30 V, I_C = 750 mA, I_{B1} = 15 mA)	t_f	−	145	−	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle ≤ 2%.

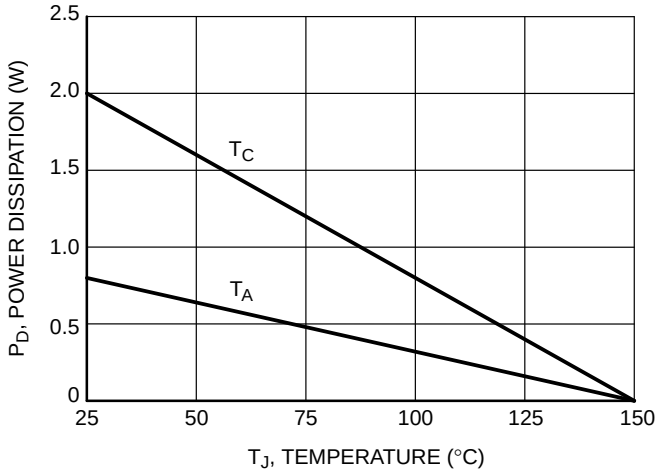

Figure 1. Power Derating

TYPICAL CHARACTERISTICS

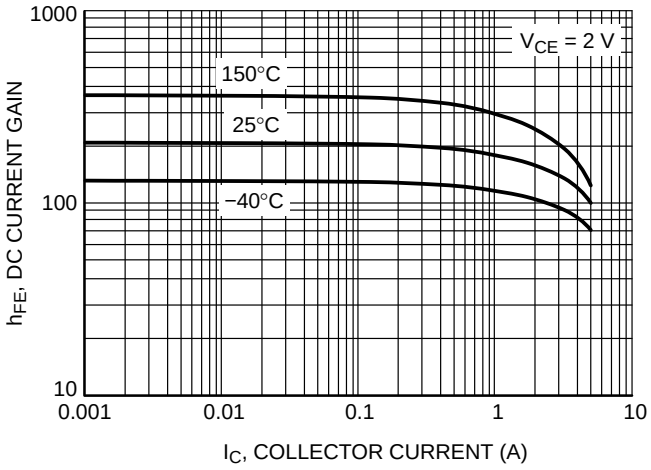

Figure 2. DC Current Gain

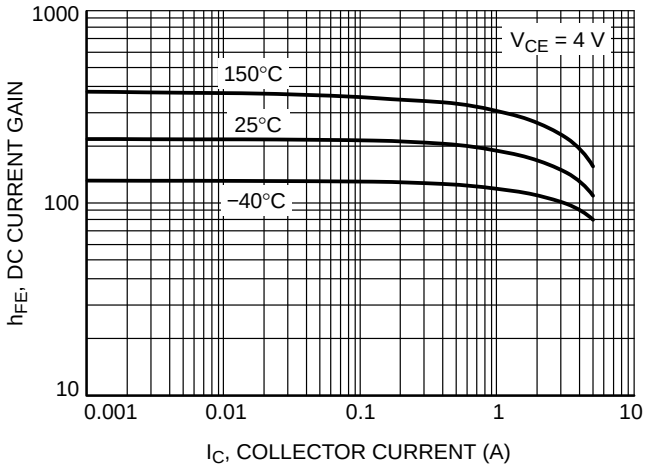

Figure 3. DC Current Gain

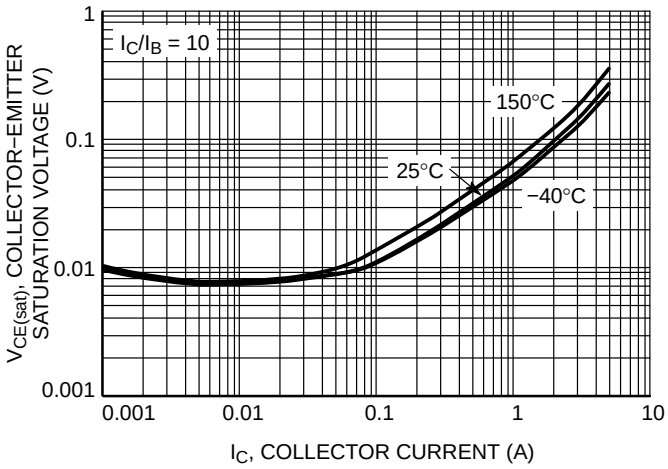

Figure 4. Collector−Emitter Saturation Voltage

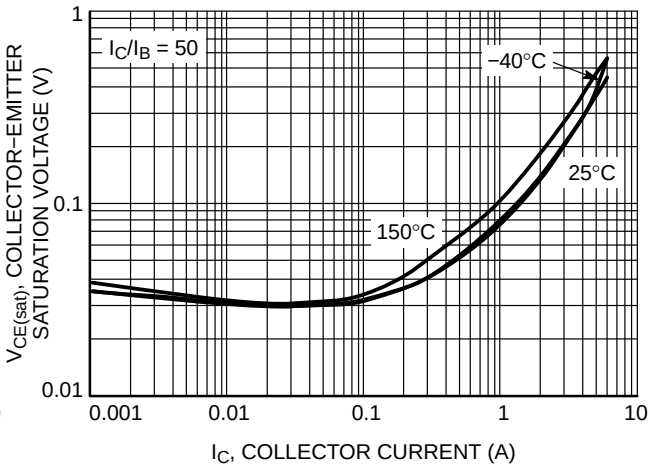

Figure 5. Collector−Emitter Saturation Voltage

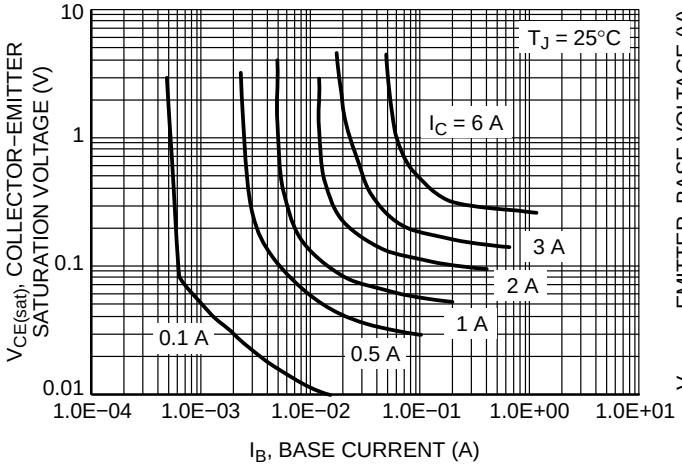

Figure 6. Collector Saturation Region

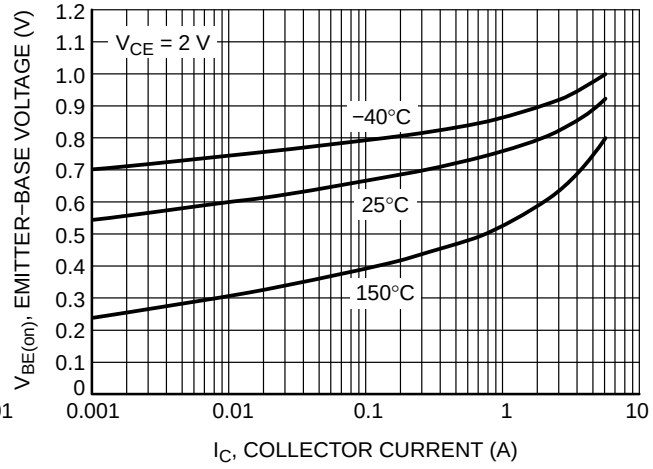

Figure 7. $V_{BE(on)}$ Voltage

TYPICAL CHARACTERISTICS

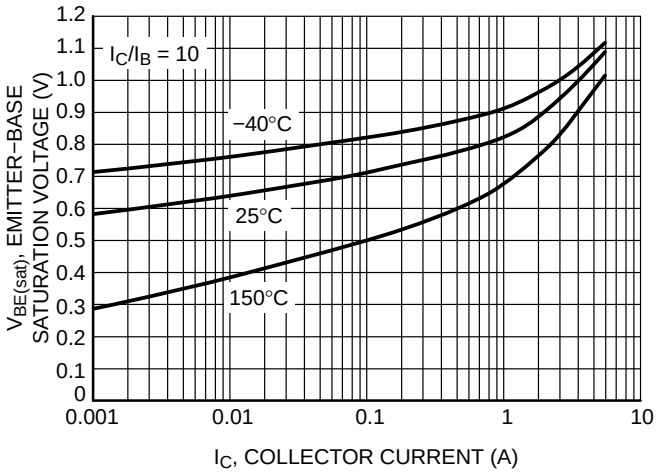

Figure 8. Base−Emitter Saturation Voltage

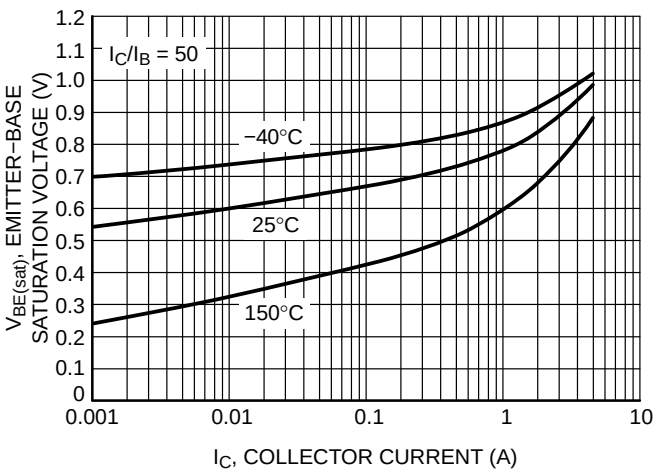

Figure 9. Base−Emitter Saturation Voltage

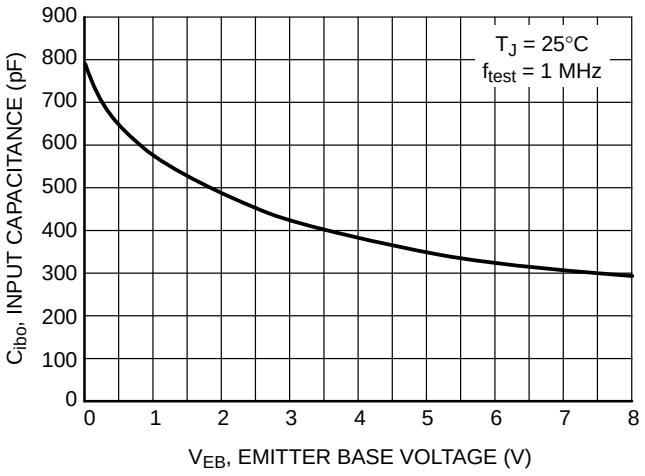

Figure 10. Input Capacitance

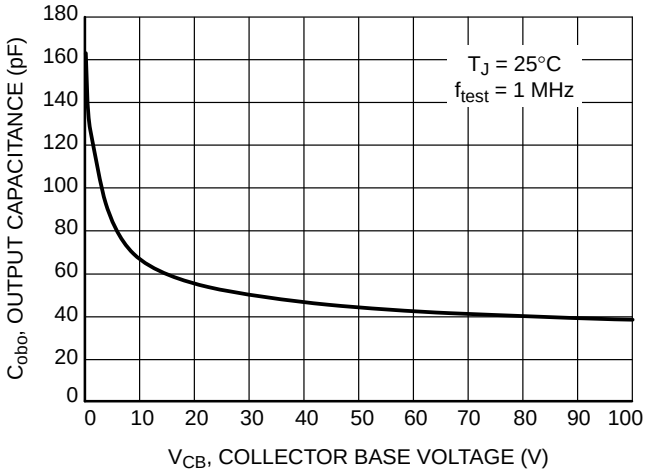

Figure 11. Output Capacitance

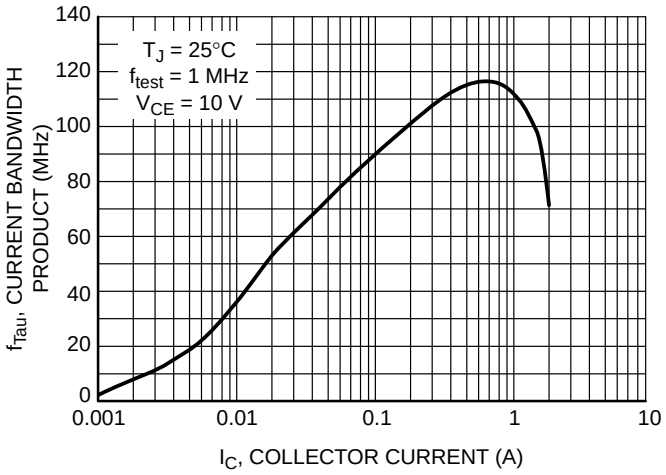

Figure 12. Current−Gain Bandwidth Product

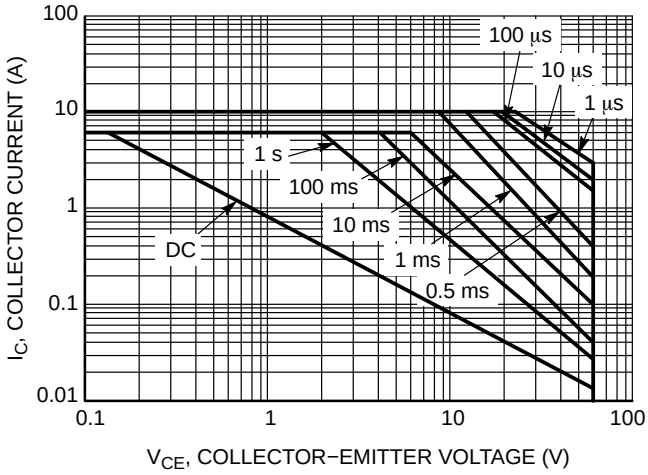

Figure 13. Safe Operating Area

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